

DATA SHEET

SPARK GAP PROTECTORS POWER SUPPLIES BK2 series

RoHS compliant & Halogen free





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Spark Gap (SPG) Data Sheet

Features

- Approximately zero leaking current before clamping voltage
- Less decay at on/off state.
- High capability to withstand repeated lightning strikes.
- Low electrode capacitance($\leq 0.8 \text{pF}$) and high isolation($\geq 100 \text{M}\Omega$).
- RoHS compliant.
- Bilateral symmetrical.
- Temperature, humidity and lightness insensitive.
- Operating temperature: -40°C ~ +85°C
- Storage temperature: -40°C ~ +125°C
- Meets MSL level 1, per J-STD-020



Applications

- Power Supplies
- Motor sparks eliminating
- Relay switching spark absorbing
- Data line pulse guarding
- Telephone/Fax/Modem
- High frequency signal transmitters/receivers
- Satellite antenna
- Radio amplifiers
- Alarm systems
- Cathode ray tubes in Monitors/TVs

Dimensions



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Electrical Characteristics

Part Number	DC Spark-over Voltage	Minimum Insulation Resistance		Maximum Capacitance (1KHz-6V _{MAX})	Surge Current	Surge Life Test
	Vs(V)	Test Voltage(V)	IR _{OHM} (MΩ)	C(pf)	Capacity (8/20µs)	8/20µs,100A
BK22000702	140±20%	50	100	0.8	1000A	200 times
BK23000702	140±30%	50	100	0.8	1000A	200 times
BK22001002	200±20%	100	100	0.8	1000A	200 times
BK22001102	220±20%	100	100	0.8	1000A	200 times
BK22001502	300±20%	100	100	0.8	1000A	200 times
BK22002002	400±20%	250	100	0.8	1000A	200 times
BK22002502	500±20%	250	100	0.8	1000A	200 times
BK22003002	600±20%	250	100	0.8	1000A	200 times
BK22003502	700±20%	250	100	0.8	1000A	200 times
BK22005002	1000±20%	500	100	0.8	1000A	200 times
BK22007502	1500±20%	500	100	0.8	1000A	200 times

Color Code

Part Number	Color Code 1	Color Code 2	Color Code 3
BK22000702	Black	Yellow	-
BK23000702	Black	Yellow	-
BK22001002	Red	-	-
BK22001102	Red	Red	-
BK22001502	Orange	-	-
BK22002002	Yellow	-	-
BK22002502	Green	-	-
BK22003002	Blue	-	-
BK22003502	Purple	-	-
BK22005002	Black	-	-
BK22007502	Brown	Green	Red

YAGEO Circuit Protection

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Test Methods and Results

Items	Test Method		Standard	
DC Spark-over Voltage	gradually incre current is 0.5r	ing discharge voltage (Vs) by easing applied DC voltage. Test nA max. And the DC voltage ithin 100V/s(Vs<1000V) or 000V).		
Insulation Resistance	terminal at reg	nsulation resistance across the gular voltage. But the test voltage he DC spark-over voltage.	Meet specified value.	
Capacitance		electrostatic capacitance by tage of less than 6V (at 1KHz) inals.		
Static Life		00pf condenser is discharged sistor. 200 times at an interval of	△Vs/Vs ≤30% Characteristics of other items must meet the specified value.	
	current applie	impulse current for specified d ±5 times, each time interval 60 reafter, outer appearance shall amined.		
Surge Current Capacity	Туре	Impulse current	No crack and no failures	
	Vs < 400V	1.2/50µs & 8/20µs, 1000A		
	Vs ≥ 400V	1.2/50 μ s & 8/20 μ s, 1000A, electrically connected with a resistor (1~2 Ω).		
Cold Resistance	Measurement temperature/2	after -40℃/1000 HRS & normal HRS.	Features are conformed to rated spec.	
Heat Resistance	Measurement temperature/2	after 125℃/1000 HRS & normal HRS.		
Humidity Resistance		after humidity 90~95℃(45℃) normal temperature/2 HRS.		
Temperature Cycle	\rightarrow normal, tem	tition of cycle -40 ℃/30min p/2 min →125 ℃/30min, after normal temp/2 HRS.		
Solder Ability	230±5℃ for 3	l immerse in molten solder sec up to the point of 1.5mm from or solder adhesion.	Lead wire is evenly covered by solder.	
Solder Heat		after lead wire is dipped up to 5mm from body into $260\pm5^\circ\!\!\!\mathrm{C}$ ec.	Conformed to rated spec.	
Pull Strength	Apply 0.5kg lo	ad for 10sec.	Lead shall not pull out to snap.	
Flexural Strength		e at the point of 2mm from body ad and back to its original point.		

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Recommended Soldering Conditions



1) Time shown in the above figures is measured from the point when chip surface reaches temperature.

2) Temperature difference in high temperature part should be within 110 $^\circ\!{\rm C}$.

3) After soldering, do not force cool, allow the parts to cool gradually.

Hand Soldering Solder iron temperature: 350±5°C

Heating time: 3 seconds max.

General attention to soldering

• High soldering temperatures and long soldering times can cause leaching of the termination, decrease in adherence strength, and the change of characteristic may occur.

• For soldering, please refer to the soldering curves above. However, please keep exposures to temperatures exceeding 200° C to fewer than 50 seconds.

• Please use a mild flux (containing less than 0.2wt% Cl). Also, if the flux is water soluble, be sure to wash thoroughly to remove any residue from the underside of components that could affect resistance.

Cleaning

When using ultrasonic cleaning, the board may resonate if the output power is too high. Since this vibration can cause cracking or a decrease in the adherence of the termination, we recommend that you use the conditions below.

Frequency: 40kHz max.

Output power: 20W/liter

Cleaning time: 5 minutes max.

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Packaging

